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NXP Semiconductors/Freescale Semiconductor, Inc. 74LVC3G04DC-Q100H

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## 74LVC3G04-Q100

## 1. General description

The 74LVC3G04-Q100 provides three inverting buffers.
Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in a mixed 3.3 V and 5 V environment.

This device is fully specified for partial power-down applications using IOFF. The loff circuitry disables the output, preventing a damaging backflow current through the device when it is powered down.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

## 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
- Specified from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ and from $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
- Wide supply voltage range from 1.65 V to 5.5 V

■ 5 V tolerant outputs for interfacing with 5 V logic

- High noise immunity
- Complies with JEDEC standard:
- JESD8-7 (1.65 V to 1.95 V )
- JESD8-5 (2.3 V to 2.7 V )
- JESD8B/JESD36 (2.7 V to 3.6 V )
- ESD protection:
- MIL-STD-883, method 3015 exceeds 2000 V
- HBM JESD22-A114F exceeds 2000 V
- MM JESD22-A115-A exceeds $200 \mathrm{~V}(\mathrm{C}=200 \mathrm{pF}, \mathrm{R}=0 \Omega)$

■ $\pm 24 \mathrm{~mA}$ output drive $\left(\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}\right)$

- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Multiple package options


## 74LVC3G04-Q100

Triple inverter

## 3. Ordering information

Table 1. Ordering information

| Type number | Package |  |  |  |
| :--- | :--- | :--- | :--- | :--- |
|  | Temperature range | Name | Description | Version |
| 74 LVC3G04DP-Q100 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | TSSOP8 | plastic thin shrink small outline package; 8 leads; <br> body width 3 mm ; lead length 0.5 mm | SOT505-2 |
| 74 LVC3G04DC-Q100 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | VSSOP8 | plastic very thin shrink small outline package; <br> 8 leads; body width 2.3 mm | SOT765-1 |

## 4. Marking

Table 2. Marking codes

| Type number | Marking code ${ }^{[1]}$ |
| :--- | :--- |
| 74LVC3G04DP-Q100 | V04 |
| 74LVC3G04DC-Q100 | V04 |

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

## 5. Functional diagram



Fig 1. Logic symbol


Fig 2. IEC logic symbol


Fig 3. Logic diagram (one driver)

## 6. Pinning information

### 6.1 Pinning



Fig 4. Pin configuration SOT505-2 and SOT765-1

### 6.2 Pin description

Table 3. Pin description

| Symbol | Pin | Description |
| :--- | :--- | :--- |
| $1 \mathrm{~A}, 2 \mathrm{~A}, 3 \mathrm{~A}$ | $1,3,6$ | data input |
| GND | 4 | ground $(0 \mathrm{~V})$ |
| $1 \mathrm{Y}, 2 \mathrm{Y}, 3 \mathrm{Y}$ | $7,5,2$ | data output |
| $\mathrm{V}_{\mathrm{CC}}$ | 8 | supply voltage |

## 7. Functional description

Table 4. Function table [1]

| Input nA | Output $\boldsymbol{n Y}$ |
| :--- | :--- |
| L | H |
| H | L |

[1] $\mathrm{H}=$ HIGH voltage level; $\mathrm{L}=$ LOW voltage level.

## 8. Limiting values

Table 5. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{C C}$ | supply voltage |  | -0.5 | +6.5 | V |
| $\mathrm{I}_{\mathrm{IK}}$ | input clamping current | $\mathrm{V}_{1}<0 \mathrm{~V}$ | -50 | - | mA |
| $V_{1}$ | input voltage |  | [1] -0.5 | +6.5 | V |
| lok | output clamping current | $\mathrm{V}_{\mathrm{O}}>\mathrm{V}_{\mathrm{CC}}$ or $\mathrm{V}_{\mathrm{O}}<0 \mathrm{~V}$ | - | $\pm 50$ | mA |
| $\mathrm{V}_{\mathrm{O}}$ | output voltage | Active mode | [1] -0.5 | $\mathrm{V}_{\mathrm{CC}}+0.5$ | V |
|  |  | Power-down mode | [1][2] -0.5 | +6.5 | V |
| $\mathrm{I}_{0}$ | output current | $\mathrm{V}_{\mathrm{O}}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{Cc}}$ | - | $\pm 50$ | mA |
| $\mathrm{I}_{\mathrm{CC}}$ | supply current |  | - | 100 | mA |
| $\mathrm{I}_{\text {GND }}$ | ground current |  | -100 | - | mA |
| $\mathrm{P}_{\text {tot }}$ | total power dissipation | $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | [3] - | 250 | mW |
| $\mathrm{T}_{\text {stg }}$ | storage temperature |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.
[2] When $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}$ (Power-down mode), the output voltage can be 5.5 V in normal operation.
[3] For TSSOP8 package: above $55^{\circ} \mathrm{C}$ the value of $\mathrm{P}_{\text {tot }}$ derates linearly with $2.5 \mathrm{~mW} / \mathrm{K}$. For VSSOP8 package: above $110^{\circ} \mathrm{C}$ the value of $\mathrm{P}_{\text {tot }}$ derates linearly with $8 \mathrm{~mW} / \mathrm{K}$.

## 9. Recommended operating conditions

Table 6. Operating conditions

| Symbol | Parameter | Conditions | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{C C}$ | supply voltage |  | 1.65 | 5.5 | V |
| $V_{1}$ | input voltage |  | 0 | 5.5 | V |
| $\mathrm{V}_{0}$ | output voltage | Active mode | 0 | $\mathrm{V}_{\text {cc }}$ | V |
|  |  | Power-down mode; $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}$ | 0 | 5.5 | V |
| Tamb | ambient temperature |  | -40 | +125 | ${ }^{\circ} \mathrm{C}$ |
| $\Delta \mathrm{t} / \Delta \mathrm{V}$ | input transition rise and fall rate | $\mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ to 2.7 V | - | 20 | $\mathrm{ns} / \mathrm{V}$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ to 5.5 V | - | 10 | $\mathrm{ns} / \mathrm{V}$ |

## 10. Static characteristics

Table 7. Static characteristics
At recommended operating conditions; voltages are referenced to GND (ground = 0 V ).

| Symbol | Parameter | Conditions | Min | Typ[1] | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | HIGH-level input voltage | $\mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ to 1.95 V | $0.65 \times \mathrm{V}_{\mathrm{CC}}$ | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$ to 2.7 V | 1.7 | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ to 3.6 V | 2.0 | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ to 5.5 V | $0.7 \times \mathrm{V}_{\mathrm{CC}}$ | - | - | V |
| $\mathrm{V}_{\text {IL }}$ | LOW-level input voltage | $\mathrm{V}_{C C}=1.65 \mathrm{~V}$ to 1.95 V | - | - | $0.35 \times V_{\text {CC }}$ | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$ to 2.7 V | - | - | 0.7 | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ to 3.6 V | - | - | 0.8 | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ to 5.5 V | - | - | $0.3 \times \mathrm{V}_{\mathrm{cc}}$ | V |
| $\mathrm{V}_{\text {OH }}$ | HIGH-level output voltage | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\text {IH }}$ or $\mathrm{V}_{\text {IL }}$ |  |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{O}}=-100 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ to 5.5 V | $\mathrm{V}_{C C}-0.1$ | - | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-4 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ | 1.2 | - | - | V |
|  |  | $\mathrm{l}_{\mathrm{O}}=-8 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$ | 1.9 | - | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-12 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ | 2.2 | - | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-24 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ | 2.3 | - | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-32 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | 3.8 | - | - | V |
| $\mathrm{V}_{\mathrm{OL}}$ | LOW-level output voltage | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\text {IH }}$ or $\mathrm{V}_{\text {IL }}$ |  |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{O}}=100 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ to 5.5 V | - | - | 0.10 | V |
|  |  | $\mathrm{l}_{\mathrm{O}}=4 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ | - | - | 0.45 | V |
|  |  | $\mathrm{l}_{\mathrm{O}}=8 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$ | - | - | 0.30 | V |
|  |  | $\mathrm{l}_{\mathrm{O}}=12 \mathrm{~mA} ; \mathrm{V}_{\mathrm{cc}}=2.7 \mathrm{~V}$ | - | - | 0.40 | V |
|  |  | $\mathrm{l}_{\mathrm{O}}=24 \mathrm{~mA} ; \mathrm{V}_{\mathrm{Cc}}=3.0 \mathrm{~V}$ | - | - | 0.55 | V |
|  |  | $\mathrm{l}_{\mathrm{O}}=32 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | - | - | 0.55 | V |
| 1 | input leakage current | $\mathrm{V}_{1}=5.5 \mathrm{~V}$ or GND; $\mathrm{V}_{\mathrm{cc}}=0 \mathrm{~V}$ to 5.5 V | - | $\pm 0.1$ | $\pm 5$ | $\mu \mathrm{A}$ |
| I OFF | power-off leakage current | $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}$; $\mathrm{V}_{1}$ or $\mathrm{V}_{\mathrm{O}}=5.5 \mathrm{~V}$ | - | $\pm 0.1$ | $\pm 10$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{CC}}$ | supply current | $\begin{aligned} & \mathrm{V}_{\mathrm{I}}=5.5 \mathrm{~V} \text { or } \mathrm{GND} ; \\ & \mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V} \text { to } 5.5 \mathrm{~V} ; \mathrm{I}_{\mathrm{O}}=0 \mathrm{~A} \end{aligned}$ | - | 0.1 | 10 | $\mu \mathrm{A}$ |
| $\Delta \mathrm{l}_{\mathrm{CC}}$ | additional supply current | $\begin{aligned} & \text { per pin; } \mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V} \text { to } 5.5 \mathrm{~V} \text {; } \\ & \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}-0.6 \mathrm{~V} ; \mathrm{I}_{\mathrm{O}}=0 \mathrm{~A} \end{aligned}$ | - | 5 | 500 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{1}$ | input capacitance | $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=\mathrm{GND}$ to $\mathrm{V}_{\mathrm{CC}}$ | - | 2.5 | - | pF |

Table 7. Static characteristics ...continued
At recommended operating conditions; voltages are referenced to GND (ground = 0 V ).

| Symbol | Parameter | Conditions | Min | Typ [1] | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | HIGH-level input voltage | $\mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ to 1.95 V | $0.65 \times \mathrm{V}_{\text {CC }}$ | - | - | V |
|  |  | $\mathrm{V}_{C C}=2.3 \mathrm{~V}$ to 2.7 V | 1.7 | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ to 3.6 V | 2.0 | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ to 5.5 V | $0.7 \times \mathrm{V}_{\mathrm{Cc}}$ | - | - | V |
| $\mathrm{V}_{\text {IL }}$ | LOW-level input voltage | $\mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ to 1.95 V | - | - | $0.35 \times V_{\text {CC }}$ | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$ to 2.7 V | - | - | 0.7 | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ to 3.6 V | - | - | 0.8 | V |
|  |  | $\mathrm{V}_{\text {CC }}=4.5 \mathrm{~V}$ to 5.5 V | - | - | $0.3 \times \mathrm{V}_{\mathrm{cc}}$ | V |
| $\mathrm{V}_{\mathrm{OH}}$ | HIGH-level output voltage | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}}$ |  |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{O}}=-100 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ to 5.5 V | $\mathrm{V}_{\mathrm{CC}}-0.1$ | - | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-4 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ | 0.95 | - | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-8 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$ | 1.7 | - | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-12 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ | 1.9 | - | - | V |
|  |  | $\mathrm{l}_{\mathrm{O}}=-24 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ | 2.0 | - | - | V |
|  |  | $\mathrm{l}_{\mathrm{O}}=-32 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | 3.4 | - | - | V |
| $\mathrm{V}_{\mathrm{OL}}$ | LOW-level output voltage | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}}$ |  |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{O}}=100 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ to 5.5 V | - | - | 0.10 | V |
|  |  | $\mathrm{l}_{\mathrm{O}}=4 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ | - | - | 0.70 | V |
|  |  | $\mathrm{l}_{\mathrm{O}}=8 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$ | - | - | 0.45 | V |
|  |  | $\mathrm{l}_{\mathrm{O}}=12 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ | - | - | 0.60 | V |
|  |  | $\mathrm{l}_{\mathrm{O}}=24 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ | - | - | 0.80 | V |
|  |  | $\mathrm{l}_{\mathrm{O}}=32 \mathrm{~mA} ; \mathrm{V}_{\mathrm{cc}}=4.5 \mathrm{~V}$ | - | - | 0.80 | V |
| 1 | input leakage current | $\mathrm{V}_{\mathrm{I}}=5.5 \mathrm{~V}$ or GND; $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}$ to 5.5 V | - | - | $\pm 20$ | $\mu \mathrm{A}$ |
| IOFF | power-off leakage current | $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}$; $\mathrm{V}_{\text {I }}$ or $\mathrm{V}_{\mathrm{O}}=5.5 \mathrm{~V}$ | - | - | $\pm 20$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{CC}}$ | supply current | $\begin{aligned} & \mathrm{V}_{\mathrm{I}}=5.5 \mathrm{~V} \text { or GND; } \\ & \mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V} \text { to } 5.5 \mathrm{~V} ; \mathrm{I}_{\mathrm{O}}=0 \mathrm{~A} \end{aligned}$ | - | - | 40 | $\mu \mathrm{A}$ |
| $\Delta l_{\text {CC }}$ | additional supply current | $\begin{aligned} & \text { per pin; } \mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V} \text { to } 5.5 \mathrm{~V} \text {; } \\ & \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}-0.6 \mathrm{~V} ; \mathrm{I}_{\mathrm{O}}=0 \mathrm{~A} \end{aligned}$ | - | - | 5000 | $\mu \mathrm{A}$ |

[1] All typical values are measured at $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$.

## 11. Dynamic characteristics

Table 8. Dynamic characteristics
Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 6.

| Symbol | Parameter | Conditions |  | $-40{ }^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | $-40{ }^{\circ} \mathrm{C}$ to +125 ${ }^{\circ} \mathrm{C}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ[ ${ }^{[1]}$ | Max | Min | Max |  |
| $\mathrm{t}_{\mathrm{pd}}$ | propagation delay | nA to nY ; see Figure 5 | [2] |  |  |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ to 1.95 V |  | 1.0 | 3.5 | 8.0 | 1.0 | 9.5 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$ to 2.7 V |  | 0.5 | 2.2 | 4.4 | 0.5 | 5.4 | ns |
|  |  | $\mathrm{V}_{C C}=2.7 \mathrm{~V}$ |  | 0.5 | 2.7 | 5.2 | 0.5 | 7.0 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ to 3.6 V |  | 0.5 | 2.7 | 4.1 | 0.5 | 5.5 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ to 5.5 V |  | 0.5 | 1.9 | 3.2 | 0.5 | 3.8 | ns |
| $\mathrm{C}_{\text {PD }}$ | power dissipation capacitance | $V_{1}=G N D$ to $V_{C C} ; V_{C C}=3.3 \mathrm{~V}$ | [3] | - | 13.5 | - | - | - | pF |

[1] Typical values are measured at $\mathrm{T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\mathrm{CC}}=1.8 \mathrm{~V}, 2.5 \mathrm{~V}, 2.7 \mathrm{~V}, 3.3 \mathrm{~V}$ and 5.0 V respectively.
[2] $t_{p d}$ is the same as $t_{P L H}$ and $t_{P H L}$.
[3] $C_{P D}$ is used to determine the dynamic power dissipation ( $P_{D}$ in $\mu \mathrm{W}$ ).
$P_{D}=C_{P D} \times V_{C C}{ }^{2} \times f_{i} \times N+\Sigma\left(C_{L} \times V_{C C}{ }^{2} \times f_{o}\right)$ where:
$f_{i}=$ input frequency in MHz ;
$\mathrm{f}_{\mathrm{o}}=$ output frequency in MHz ;
$\mathrm{C}_{\mathrm{L}}=$ output load capacitance in pF ;
$\mathrm{V}_{\mathrm{CC}}=$ supply voltage in V ;
$\mathrm{N}=$ number of inputs switching;
$\Sigma\left(C_{L} \times V_{C C}{ }^{2} \times f_{0}\right)=$ sum of outputs.

## 12. Waveforms



Measurement points are given in Table 9.
$\mathrm{V}_{\mathrm{OL}}$ and $\mathrm{V}_{\mathrm{OH}}$ are typical output voltage levels that occur with the output load.
Fig 5. The input ( $n A$ ) to output ( $n Y$ ) propagation delays

Table 9. Measurement points

| Supply voltage | Input | Output |
| :--- | :--- | :--- |
| $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{M}}$ | $\mathrm{V}_{\mathrm{M}}$ |
| 1.65 V to 1.95 V | $0.5 \times \mathrm{V}_{\mathrm{CC}}$ | $0.5 \times \mathrm{V}_{\mathrm{CC}}$ |
| 2.3 V to 2.7 V | $0.5 \times \mathrm{V}_{\mathrm{CC}}$ | $0.5 \times \mathrm{V}_{\mathrm{CC}}$ |
| 2.7 V | 1.5 V | 1.5 V |
| 3.0 V to 3.6 V | 1.5 V | 1.5 V |
| 4.5 V to 5.5 V | $0.5 \times \mathrm{V}_{\mathrm{CC}}$ | $0.5 \times \mathrm{V}_{\mathrm{CC}}$ |



Test data is given in Table 10.
Definitions for test circuit:
$R_{L}=$ Load resistance.
$C_{L}=$ Load capacitance including jig and probe capacitance.
$\mathrm{R}_{\mathrm{T}}=$ Termination resistance should be equal to the output impedance $\mathrm{Z}_{\mathrm{o}}$ of the pulse generator.
$\mathrm{V}_{\mathrm{EXT}}=$ External voltage for measuring switching times.
Fig 6. Test circuit for measuring switching times

Table 10. Test data

| Supply voltage | Input | Load |  | $\mathbf{V}_{\mathbf{E X T}}$ |  |
| :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathbf{V}_{\mathrm{CC}}$ | $\mathbf{V}_{\mathbf{I}}$ | $\mathbf{t}_{\mathbf{r}}=\mathbf{t}_{\mathbf{f}}$ | $\mathbf{C}_{\mathbf{L}}$ | $\mathbf{R}_{\mathbf{L}}$ | $\mathbf{t}_{\mathbf{P L H}}, \mathbf{t}_{\mathbf{P H L}}$ |
| 1.65 V to 1.95 V | $\mathrm{~V}_{\mathrm{CC}}$ | $\leq 2.0 \mathrm{~ns}$ | 30 pF | $1 \mathrm{k} \Omega$ | open |
| 2.3 V to 2.7 V | $\mathrm{~V}_{\mathrm{CC}}$ | $\leq 2.0 \mathrm{~ns}$ | 30 pF | $500 \Omega$ | open |
| 2.7 V | 2.7 V | $\leq 2.5 \mathrm{~ns}$ | 50 pF | $500 \Omega$ | open |
| 3.0 V to 3.6 V | 2.7 V | $\leq 2.5 \mathrm{~ns}$ | 50 pF | $500 \Omega$ | open |
| 4.5 V to 5.5 V | $\mathrm{~V}_{\mathrm{CC}}$ | $\leq 2.5 \mathrm{~ns}$ | 50 pF | $500 \Omega$ | open |

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## 13. Package outline

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm ; lead length 0.5 mm SOT505-2


DIMENSIONS (mm are the original dimensions)

| UNIT | $\mathbf{A}$ <br> max. | $\mathbf{A}_{\mathbf{1}}$ | $\mathbf{A}_{\mathbf{2}}$ | $\mathbf{A}_{\mathbf{3}}$ | $\mathbf{b}_{\mathbf{p}}$ | $\mathbf{c}$ | $\mathbf{D}^{(1)}$ | $\mathbf{E}^{(\mathbf{1})}$ | $\mathbf{e}$ | $\mathbf{H}_{\mathbf{E}}$ | $\mathbf{L}$ | $\mathbf{L}_{\mathbf{p}}$ | $\mathbf{v}$ | $\mathbf{w}$ | $\mathbf{y}$ | $\mathbf{Z}^{(1)}$ | $\boldsymbol{\theta}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 1.1 | 0.15 | 0.95 | 0.25 | 0.38 | 0.18 | 3.1 | 3.1 | 0.65 | 4.1 | 0.5 | 0.47 | 0.2 | 0.13 | 0.1 | 0.70 | $8^{\circ}$ |
|  | 0.00 | 0.75 |  | 0.22 | 0.08 | 2.9 | 2.9 | 0.6 | 3.9 | 0.3 | 0.33 | 0.2 |  | 0 | 0.35 | $0^{\circ}$ |  |

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

| OUTLINE <br> VERSION | REFERENCES |  |  |  | EUROPEAN <br> PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  | $02-01-16$ |

Fig 7. Package outline SOT505-2 (TSSOP8)


DIMENSIONS ( mm are the original dimensions)

| UNIT | A max. | $\mathrm{A}_{1}$ | $\mathrm{A}_{2}$ | $\mathrm{A}_{3}$ | $\mathrm{b}_{\mathrm{p}}$ | c | $D^{(1)}$ | $E^{(2)}$ | e | $\mathrm{H}_{\mathrm{E}}$ | L | $\mathrm{L}_{\mathrm{p}}$ | Q | v | w | y | $Z^{(1)}$ | $\theta$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 1 | $\begin{aligned} & 0.15 \\ & 0.00 \end{aligned}$ | $\begin{aligned} & \hline 0.85 \\ & 0.60 \end{aligned}$ | 0.12 | $\begin{aligned} & 0.27 \\ & 0.17 \end{aligned}$ | $\begin{aligned} & \hline 0.23 \\ & 0.08 \end{aligned}$ | $\begin{aligned} & 2.1 \\ & 1.9 \end{aligned}$ | $\begin{aligned} & \hline 2.4 \\ & 2.2 \end{aligned}$ | 0.5 | $\begin{aligned} & 3.2 \\ & 3.0 \end{aligned}$ | 0.4 | $\begin{aligned} & 0.40 \\ & 0.15 \end{aligned}$ | $\begin{aligned} & 0.21 \\ & 0.19 \end{aligned}$ | 0.2 | 0.13 | 0.1 | 0.4 0.1 | $8^{\circ}$ $0^{\circ}$ |

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES |  |  | EUROPEAN PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  |
| SOT765-1 |  | MO-187 |  | $\square$ | 02-06-07 |

Fig 8. Package outline SOT765-1 (VSSOP8)

## 14. Abbreviations

Table 11. Abbreviations

| Acronym | Description |
| :--- | :--- |
| CMOS | Complementary Metal-Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| MIL | Military |
| MM | Machine Model |
| TTL | Transistor-Transistor Logic |

## 15. Revision history

Table 12. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| :--- | :--- | :--- | :--- | :--- |
| 74LVC3G04_Q100 v. 1 | 20130514 | Product data sheet | - | - |

electronic components

## 16. Legal information

### 16.1 Data sheet status

| Document status $\underline{[1][2]}$ | Product status $[$ [3] | Definition |
| :--- | :--- | :--- |
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

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[2] The term 'short data sheet' is explained in section "Definitions".
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